

# Metal Foil Current Sense Resistors, 4-Terminal Low Value (Down to 0.001 $\Omega$ )



#### **FEATURES**

- 4-terminal design
- Ultra low sensing resistance
- Low TCR (down to 100 ppm/°C)
- Sulfur resistant
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



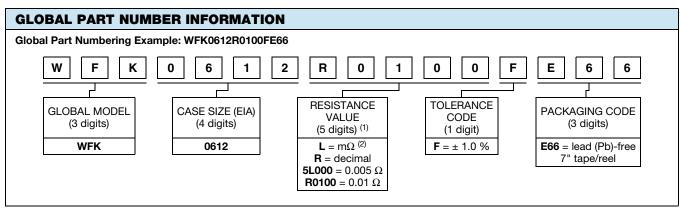
ROHS COMPLIANT HALOGEN FREE

<u>GREEN</u> (5-2008)

#### **APPLICATIONS**

- Switching power supply
- · Voltage regulation module
- DC/DC converter, adaptor, battery pack, charger
- · Pad and cell phone
- · Power management

STANDARD ELECTRICAL SPECIFICATIONS									
GLOBAL MODEL	SIZE	POWER RATING W	TOLERANCE %	RESISTANCE VALUES AVAILABLE $m\Omega$	WEIGHT (typical) g/1000 pieces				
WFK0612	0612	1	± 1	1, 2, 3, 5, 10	7.40				



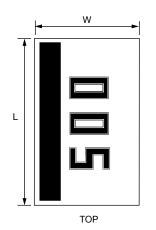
#### Notes

- (1) Resistance values are available per E12 and E24 decades; <a href="www.vishay.com/doc?28372">www.vishay.com/doc?28372</a>
- (2) Use "L" for resistance values < 0.01  $\Omega$



TECHNICAL SPECIFICATIONS							
PARAMETER	UNIT	RESISTOR CHARACTERISTICS WFK0612					
Temperature coefficient	ppm/°C	$_{\pm}$ 150 for 1 m $\Omega$ and 2 m $\Omega$					
·		$\pm$ 100 for 3 m $\Omega$ to 10 m $\Omega$					
Operating temperature range	°C	-55 to +170					
Maximum working voltage	V	(P x R) <sup>1/2</sup>					
Maximum element temperature	°C	170					

## **DIMENSIONS** in inches (millimeters)



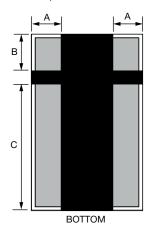




Fig. 1

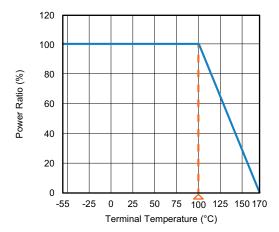
Fig. 2

TYPE	RESISTANCE	<b>DIMENSIONS</b> (in millimeters)						
(INCH SIZE)	RANGE (m $\Omega$ )	L	W	t	Α	В	C	
WFK0612	1 to 10	3.1 ± 0.20	1.6 ± 0.20	$0.5 \pm 0.20$	0.45 ± 0.20	0.45 ± 0.20	$2.2 \pm 0.20$	

#### Note

• 0402 has no marking; 0603, 0805, 1206 marking shows two digits for resistance

#### **DERATING**





### **PERFORMANCES**

ENV	ENVIRONMENTAL PERFORMANCE							
NO.	ITEM	TEST CONDITION	SPECIFICATION					
1	Short time overload	5 times rated power for 5 seconds (JIS-C5202-5.5)	$\Delta R$ : ± (1 % + 0.0005 $\Omega$ )					
2	Temperature coefficient of resistance (TCR)	+25 °C / +125 °C (JIS-C5202-5.2) TCR (ppm/°C) = $\frac{\Delta R}{R \times \Delta t} \times 10^6$	Refer to Electrical Specification					
3	Damp heat with load	The specimens shall be placed in a chamber and subjected to a relative humidity of 90 % to 95 % and a temperature of $40^{\circ}\text{C} \pm 2^{\circ}\text{C}$ for the period of 1000 hours with applying rated power 1.5 hours ON and 0.5 hour OFF. (MIL-STD-202, method 103)	ΔR: ± (1 % + 0.0005 Ω)					
4	High temperature exposure	The chip (mounted on board) is exposed in the heat chamber 125 °C $\pm$ 3 °C for 1000 hours. (JIS-C5202-7.2)	ΔR: ± (1 % + 0.0005 Ω)					
5	Load life	Apply rated power at 70 °C $\pm$ 2 °C for 1000 hours with 1.5 hours ON and 0.5 hour OFF. (JIS-C5202-7.10)	$\Delta R$ : ± (1 % + 0.0005 $\Omega$ )					
6	Rapid change of temperature	The chip (mounted on board) is exposed, -55 °C $\pm$ 3 °C (30 min.) / +155 °C $\pm$ 2 °C (30 min.) for 5 cycles. The following conditions as the following figure. (JIS-C5202-7.4) Ambient temperature +155 ( $\pm$ 2) °C +25 ( $\pm$ 2) °C +25 ( $\pm$ 2) °C +25 ( $\pm$ 3) °C 1 cycle	ΔR: ± (1 % + 0.0005 Ω)					

FUN	FUNCTION PERFORMANCE							
NO.	ITEM	TEST CONDITION	SPECIFICATION					
1	Bending strength	Mount the chip to test substrate. Apply pressure in direction of arrow unit band width reaches 2 mm (+0.2 / -0 mm) illustrated in the figure below and hold for 10 s ± 1 s. (JIS-C5202-6.1)  Position before bend  Testing printed circuit board	$\Delta R$ : ± (1 % + 0.0005 $\Omega$ )					
2	Solvent resistance	Complete immersion of specimens in isopropyl alcohol for 3 (+5, -0) min. 25 $^{\circ}$ C $_{\pm}$ 5 $^{\circ}$ C. (MIL-STD-202, method 215)	Verify marking permanency. (not required for laser etched parts or parts with no marking)					
3	Resistance to solder heat	The specimen chip shall be immersed into the flux specified in the solder bath 260 $^{\circ}$ C $\pm$ 5 $^{\circ}$ C for 10 s $\pm$ 1 s. (MIL-STD-202, method 210)	$\Delta R$ : ± (1 % + 0.0005 $\Omega$ )					



FUNCTION PERFORMANCE							
NO.	ITEM	TEST CONDITION	SPECIFICATION				
4	Solderability	The specimen chip shall be immersed into the flux specified in the solder bath 235 °C $\pm$ 5 °C for 2 s $\pm$ 0.5 s. It shall be immersed to a point 10 mm from its root. (Sn96.5 / Ag3.0 / Cu0.5) (JIS-C5 202-6.11)  Molten solder  Specimen SMD $h = 10 \text{ mm}$ $H = 10 \text{ mm min.}$	Solder shall be covered 95 % or more of the electrode area				

#### **Notes**

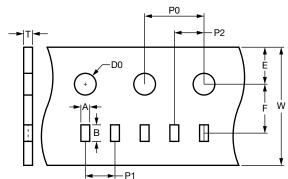
- 0.5 W with total solder pad trace size of 100 mm<sup>2</sup>. The surface temperature of component should below 100 °C
- 1.0 W with total solder pad trace size of 100 mm<sup>2</sup>. The surface temperature of component should below 100 °C

TAPE PACKAGING SPECIFICATIONS							
MODEL	REEL						
	TAPE WIDTH	DIAMETER	PIECES/REEL				
WFK0612	Embossed paper tape	178 mm / 7"	5000				

#### Note

• Embossed carrier tape per EIA (EIAJ)

#### PAPER TAPE SPECIFICATIONS



TYPE	RESISTANCE	CARRIER DIMENSIONS (in millimeters)									
	RANGE	Α	В	Е	F	W	P0	P1	P2	D0	T
WFK0612	1 m $\Omega$ to 10 m $\Omega$	$2.0 \pm 0.05$	$3.6 \pm 0.05$	1.75 ± 0.1	$3.5 \pm 0.05$	$8.0 \pm 0.2$	$4.0 \pm 0.1$	$2.0 \pm 0.1$	$2.0 \pm 0.05$	1.55 ± 0.05	0.75 ± 0.1

#### **Notes**

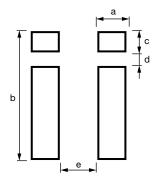
- Embossed carrier tape per EIA (EIAJ)
- Additional packaging details at <a href="www.vishay.com/doc?20051">www.vishay.com/doc?20051</a>



#### **STORAGE CONDITIONS**

Temperature: 5 °C to 35 °C, humidity: 40 % to 75 %

#### RECOMMENDED SOLDER PAD LAYOUT



TYPF	PAD LAYOUT DIMENSIONS (in millimeters)						
ITPE	а	b	С	d	е		
0612 (1 m $\Omega$ to 10 m $\Omega$ )	1.0	3.8	0.80	0.30	0.60		

#### Note

• Recommend to use the steel plate which thickness > 100 μm to avoid the insufficient solder height

#### **SOLDERING RECOMMENDATIONS**

- Peak reflow temperatures and durations:
  - IR reflow peak = 260 °C max. for 10 s
  - Wave solder = 260 °C max. for 10 s
- Compatible with lead and lead (Pb)-free solder reflow processes
- Recommended IR reflow profile for surface mount devices: <a href="www.vishay.com/doc?31052">www.vishay.com/doc?31052</a>



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